# SURFACE MOUNT UES RECTIFIERS

High Efficiency, 2.5A, 25nSec

# UPR5 UPR10 UPR15

#### FEATURES

- High Power Surface Mount Package
- Ultra-Fast Recovery Time (25nS)
- Low Forward Voltage
- Integral Heat Sink/Locking Tabs
- Compatible with Automatic Insertion
  Equipment
- Full Metallic Bottom Eliminates Flux Entrapment

#### DESCRIPTION

In Microsemi's new Powermite SMT package, these high efficiency ultrafast rectifiers offer the power handling capabilities previously found only in much larger packages. They are ideal for SMD applications that operate at high frequencies.

In addition to its size advantages, Powermite package features include a full metallic bottom that eliminates the possibility of solder flux entrapment during assembly, and a unique locking tab acts as an integral heat sink. Its innovative design makes this device ideal for use with automatic insertion equipment.

## ABSOLUTE MAXIMUM RATINGS

Maximum Reverse Voltage, UPR5	V
Maximum Reverse Voltage, UPR10	V
Maximum Reverse Voltage, UPR15	
Maximum Average Output Current, T <sub>TAB 1</sub> = 75°C	A*
Thermal Resistance, Junction to Tab	
Thermal Resistance, Junction to Bottom	W
Non-Repetitive Sinusoidal Surge Current (8.3mS)25	A
Operating and Storage Temperature	

\* WHEN MOUNTED ON A PC BOARD WITH 2 OZ. COPPER.



## MECHANICAL SPECIFICATIONS

Micro semi Corp. Watertown

TEST	CONDITIONS	LIMIT	UNITS
Forward Voltage, V <sub>F</sub>	I <sub>F</sub> = 2A	0.975	Volts
Forward Voltage, V <sub>F</sub>	$I_{\rm F} = 2A, T_{\rm J} = 100^{\circ}{\rm C}$	0.895	Volts
Reverse Current, IR	V <sub>R</sub> = Max Rating	2.0	μAmps
Reverse Current, IR	V <sub>R</sub> = Max Rating, T <sub>J</sub> = 100°C	50	μAmps
Reverse Recovery Time, T <sub>RR</sub>	$I_{F} = 0.5A, I_{R} = 1.0A$ $I_{REC} = 0.25A$	25	nSec

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless noted)



